





1U 1/2 MIL-810 MILITARY COMPUTER





- 1U ½ Rugged Military Server
- Intel® Coffee Lake Xeon® E-2276ML
- DDR4 Up to 128GB, NVMe Up to 2TB
- Military D38999 Connectors Support: 2 x mini DP,
 3 x LAN, 3 x USB 3.0, 8xDIO(4xDI/4xDO)
- Design for Naval Defense System, withstand 75G rms Shock
- 9V~36V DC-in, MIL-STD-461 EMI Filter
- Extended Temperature:-40~+70 Degree

Specifications

SYSTEM

Processor	Intel® 9th Gen. Xeon® E-2276ML (12M Cache, up to 2.0/4.2 GHz)	
Memory type	4 x DDR4 2666MHz up to 128GB	
Chipset	CM246	
DISPLAY		
Processor Graphics	Intel® UHD Graphics P630	
STORAGE		
Storage(1)	NVMe M.2 up to 2TB	
INTERFACE CAR	D	
Digital Input/Output	8 bit digital I/O , split into 2 groups of 4 , Programmable I/O	
FRONT I/O		
X1	1x DC (Amphenol TV07RW09-98P)	
X2	1x 3 DIO, Mic-In/Line Out (Amphenol TV07RW-13-35SD)	
X3	1x LAN (Amphenol TV07RW-9-09S)	
X4	1x LAN (Amphenol TV07RW-9-09S)	
X5	1x LAN (Amphenol TV07RW-9-09S)	
	Power Button with LED backlight	
REAR I/O		
X6	1x DVI (Amphenol TV07RW-13-35S)	
X7	1x DVI (Amphenol TV07RW-13-35S)	
X8	1x USB 3.0 (Amphenol USB3FTV7AZNF312)	
X9	1x USB 3.0 (Amphenol USB3FTV7AZNF312)	
X10	1x USB 3.0 (Amphenol USB3FTV7AZNF312)	
Power Requir	EMENT	
Power Input	MIL-STD 461 18V~36V	

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Dimension (W x D x H)	220 x400 x 44mm
Chassis	Aluminum Alloy, Corrosion Resistant
Finish	Anodic aluminum oxide (Color Iron gray)
Cooling	Natural Passive Convection/Conduction. No Moving Parts
Ingress Protection	IP65

ENVIRONMENTAL

MIL-STD-810 Testing Methods (Operating)

Method 502.5 Procedure 2	Low Temperature	-40°C, 4 hours, ±3°C
Method 501.5 Procedure 2	High Temperature	+70°C, 4 hours, ±3°C
Method 507.5	Humidity	85%-95% RH without condensation, 24 hours/ cycle, conduct 10 cycles.
Method 514.6	Vibration	5-500Hz 5.0 g rms , 30mins by Z axis. 5-500Hz 7.0 g rms , 30mins by X/Y axis
Method 516.6	Shock	50 g, 11ms.

MIL-STD-810 Testing Methods (None-Operating)

MIL-STD-461 Testing Methods (EMC)		
Method 516.6	Shock	75 g, 6ms.
Method 514.6	Vibration	5-500Hz 7.0 g rms, 30mins by Z axis. 5-500Hz 10.0 g rms,30mins by X/Y axis
Method 501.5	High Temperature (Storage)	+85°C, 4 hours, change rate:≦20°C/ Hour
Method 502.5	Low Temperature (Storage)	-40°C, 4 hours, change rate:≦20°C/ Hour
	Low Temperature	-10°C 1 hours change rate: < 20°C/Hour

MIL-STD-461 Testing Methods (EMC)

CE102 basic curve	Power Leads	10kHz - 30 MHz
RE102	Electric Field	(1.5 MHz) -30 MHz - 5 GHz
RS103	Electric Field	1.5 MHz - 5 GHz, 50 V/m equal for all frequencies

	Radiated Susceptibility	2 MHz-80 Mhz 50V/m equal for all frequencies
		80 MHz - 3 GHz 50V/m equal for all frequencies
		3 GHz - 5 GHz, 50V/m equal for all frequencies
EN61000-4-2	Electromagnetic Compatibility	Air discharge: 8 kV, Contact discharge: 6kV
EN 61000-4-3	Electromagnetic Compatibility	0 V/m
EN 61000-4-4	Electromagnetic Compatibility	Signal and DC-Net: 1 kV
EN 61000-4-5	Electromagnetic Compatibility	Leads vs. ground potential 1kV, Signal und DC-Net: 0.5 kV
EN55022	Radio Disturbance	Class A
* Option Test item: CS	5101/CS114/CS115/CS116/	RS101/RS103/RE103/CE106
MIL-STD-1275 Test	ing Methods	
Steady State	20V~33V	
Surge Low	18V/500ms	
Surge High	100V/500ms	
Others		
Reliability	No Moving Parts; Passive Cooling. Designed & Manufactured using ISO 9001/2005 Certified Quality Program.	
Operating Temp.	-40 to +70°C (ambient with air flow)	
Storage Temp.	-40 to +85°C	
Relative Humidity	5% to 95%, non-condensing.	

Ordering Information

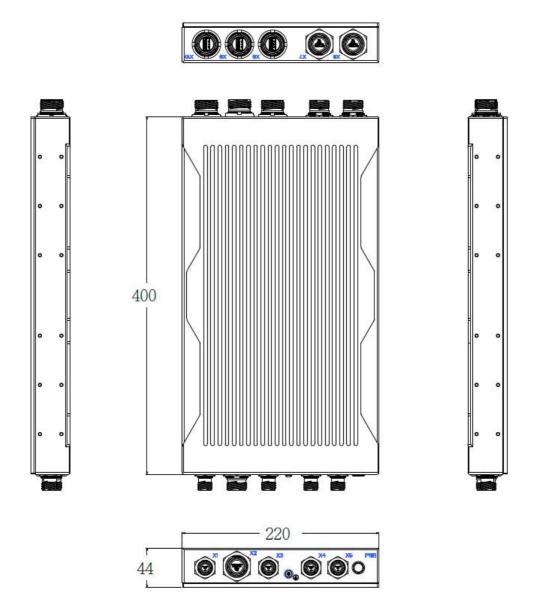
THOR100X4-D10

MIL-STD Fanless Rugged Computer with Intel® 9th Gen Xeon® E-2276ML, IP65 , with 10 MIL-DTL-D38999 Connectors, Operating Temp. -40 to 70° C

THOR100X4-D9

MIL-STD Fanless Rugged Computer with Intel® 9th Gen Intel® Core i7-9850HL, IP65, with 9 MIL-DTL-D38999 Connectors, Operating Temp. -40 to 70°C

Dimension



Front D38999 I/O



Rear D38999 I/0

